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NO.791 P.1/23

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:	)	Atty. Docket No.:
DEANE ET AL.	)	78153CIP1(17-2 US CIP)
	)	
Serial No. 10/775,395	)	Art Unit: 1725
	)	
Filing Date: FEBRUARY 10, 2004	)	Examiner:
	)	TRAN, LEN
Confirmation No. 8888	)	
	)	
For: SOLDER BONDING TECHNIQUE FOR	)	
ASSEMBLING A TILTED CHIP OR	)	
SUBSTRATE	)	

VIA FACSIMILE NO. 703-872-9306

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
U.S.A.

AMENDMENT

Dear Sir:

In response to the Office Action dated April 1, 2005  
please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of  
claims, which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.

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